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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	10MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	14KB (8K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	A/D 5x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c76-10i-so

PIC16C7X

NOTES:

PIC16C7X

TABLE 4-2: PIC16C73/73A/74/74A SPECIAL FUNCTION REGISTER SUMMARY (Cont'd)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets (2)						
Bank 1																	
80h ⁽⁴⁾	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								0000 0000	0000 0000						
81h	OPTION	RBU	INTEG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111						
82h ⁽⁴⁾	PCL	Program Counter's (PC) Least Significant Byte								0000 0000	0000 0000						
83h ⁽⁴⁾	STATUS	IRP ⁽⁷⁾	RP1 ⁽⁷⁾	RP0	TO	PD	Z	DC	C	0001 1xxx	000q quuu						
84h ⁽⁴⁾	FSR	Indirect data memory address pointer								xxxx xxxx	uuuu uuuu						
85h	TRISA	—	—	PORTA Data Direction Register						--11 1111	--11 1111						
86h	TRISB	PORTB Data Direction Register								1111 1111	1111 1111						
87h	TRISC	PORTC Data Direction Register								1111 1111	1111 1111						
88h ⁽⁵⁾	TRISD	PORTD Data Direction Register								1111 1111	1111 1111						
89h ⁽⁵⁾	TRISE	IBF	OBF	IBOV	PSPMODE	—	PORTE Data Direction Bits			0000 -111	0000 -111						
8Ah ^(1,4)	PCLATH	—	—	—	Write Buffer for the upper 5 bits of the Program Counter						---0 0000	---0 0000					
8Bh ⁽⁴⁾	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u						
8Ch	PIE1	PSPIE ⁽³⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000						
8Dh	PIE2	—	—	—	—	—	—	—	CCP2IE	---- ---0	---- ---0						
8Eh	PCON	—	—	—	—	—	—	POR	BOR ⁽⁶⁾	---- --qq	---- --uu						
8Fh	—	Unimplemented								—	—						
90h	—	Unimplemented								—	—						
91h	—	Unimplemented								—	—						
92h	PR2	Timer2 Period Register								1111 1111	1111 1111						
93h	SSPADD	Synchronous Serial Port (I ² C mode) Address Register								0000 0000	0000 0000						
94h	SSPSTAT	—	—	D/A	P	S	R/W	UA	BF	--00 0000	--00 0000						
95h	—	Unimplemented								—	—						
96h	—	Unimplemented								—	—						
97h	—	Unimplemented								—	—						
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010						
99h	SPBRG	Baud Rate Generator Register								0000 0000	0000 0000						
9Ah	—	Unimplemented								—	—						
9Bh	—	Unimplemented								—	—						
9Ch	—	Unimplemented								—	—						
9Dh	—	Unimplemented								—	—						
9Eh	—	Unimplemented								—	—						
9Fh	ADCON1	—	—	—	—	—	PCFG2	PCFG1	PCFG0	---- -000	---- -000						

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented read as '0'.

Shaded locations are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8> whose contents are transferred to the upper byte of the program counter.

2: Other (non power-up) resets include external reset through MCLR and Watchdog Timer Reset.

3: Bits PSPIE and PSPIF are reserved on the PIC16C73/73A, always maintain these bits clear.

4: These registers can be addressed from either bank.

5: PORTD and PORTE are not physically implemented on the PIC16C73/73A, read as '0'.

6: Brown-out Reset is not implemented on the PIC16C73 or the PIC16C74, read as '0'.

7: The IRP and RP1 bits are reserved on the PIC16C73/73A/74/74A, always maintain these bits clear.

8.5 Resetting Timer1 using a CCP Trigger Output

Applicable Devices

72	73	73A	74	74A	76	77
----	----	-----	----	-----	----	----

The CCP2 module is not implemented on the PIC16C72 device.

If the CCP1 or CCP2 module is configured in compare mode to generate a "special event trigger" (CCP1M3:CCP1M0 = 1011), this signal will reset Timer1.

Note: The special event triggers from the CCP1 and CCP2 modules will not set interrupt flag bit TMR1IF (PIR1<0>).

Timer1 must be configured for either timer or synchronized counter mode to take advantage of this feature. If Timer1 is running in asynchronous counter mode, this reset operation may not work.

In the event that a write to Timer1 coincides with a special event trigger from CCP1 or CCP2, the write will take precedence.

In this mode of operation, the CCPRxH:CCPRxL registers pair effectively becomes the period register for Timer1.

8.6 Resetting of Timer1 Register Pair (TMR1H, TMR1L)

Applicable Devices

72	73	73A	74	74A	76	77
----	----	-----	----	-----	----	----

TMR1H and TMR1L registers are not reset to 00h on a POR or any other reset except by the CCP1 and CCP2 special event triggers.

T1CON register is reset to 00h on a Power-on Reset or a Brown-out Reset, which shuts off the timer and leaves a 1:1 prescale. In all other resets, the register is unaffected.

8.7 Timer1 Prescaler

Applicable Devices

72	73	73A	74	74A	76	77
----	----	-----	----	-----	----	----

The prescaler counter is cleared on writes to the TMR1H or TMR1L registers.

TABLE 8-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
0Bh,8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ^(1,2)	ADIF	RCIF ⁽²⁾	TXIF ⁽²⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE ^(1,2)	ADIE	RCIE ⁽²⁾	TXIE ⁽²⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
0Eh	TMR1L	Holding register for the Least Significant Byte of the 16-bit TMR1 register							xxxx xxxx	uuuu uuuu	
0Fh	TMR1H	Holding register for the Most Significant Byte of the 16-bit TMR1 register							xxxx xxxx	uuuu uuuu	
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR1ON	--00 0000	--uu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by the Timer1 module.

Note 1: Bits PSPIE and PSPIF are reserved on the PIC16C73/73A/76, always maintain these bits clear.

2: The PIC16C72 does not have a Parallel Slave Port or a USART, these bits are unimplemented, read as '0'.

To enable the serial port, SSP Enable bit, SSPEN (SSPCON<5>) must be set. To reset or reconfigure SPI mode, clear bit SSPEN, re-initialize the SSPCON register, and then set bit SSPEN. This configures the SDI, SDO, SCK, and SS pins as serial port pins. For the pins to behave as the serial port function, they must have their data direction bits (in the TRISC register) appropriately programmed. That is:

- SDI must have TRISC<4> set
- SDO must have TRISC<5> cleared
- SCK (Master mode) must have TRISC<3> cleared
- SCK (Slave mode) must have TRISC<3> set
- SS must have TRISA<5> set

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value. An example would be in master mode where you are only sending data (to a display driver), then both SDI and SS could be used as general purpose outputs by clearing their corresponding TRIS register bits.

Figure 11-10 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge, and latched on the opposite edge of the clock. Both processors should be programmed to same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application firmware. This leads to three scenarios for data transmission:

- Master sends data — Slave sends dummy data
- Master sends data — Slave sends data
- Master sends dummy data — Slave sends data

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2) is to broadcast data by the firmware protocol.

In master mode the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SCK output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "line activity monitor" mode.

In slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched the interrupt flag bit SSPIF (PIR1<3>) is set.

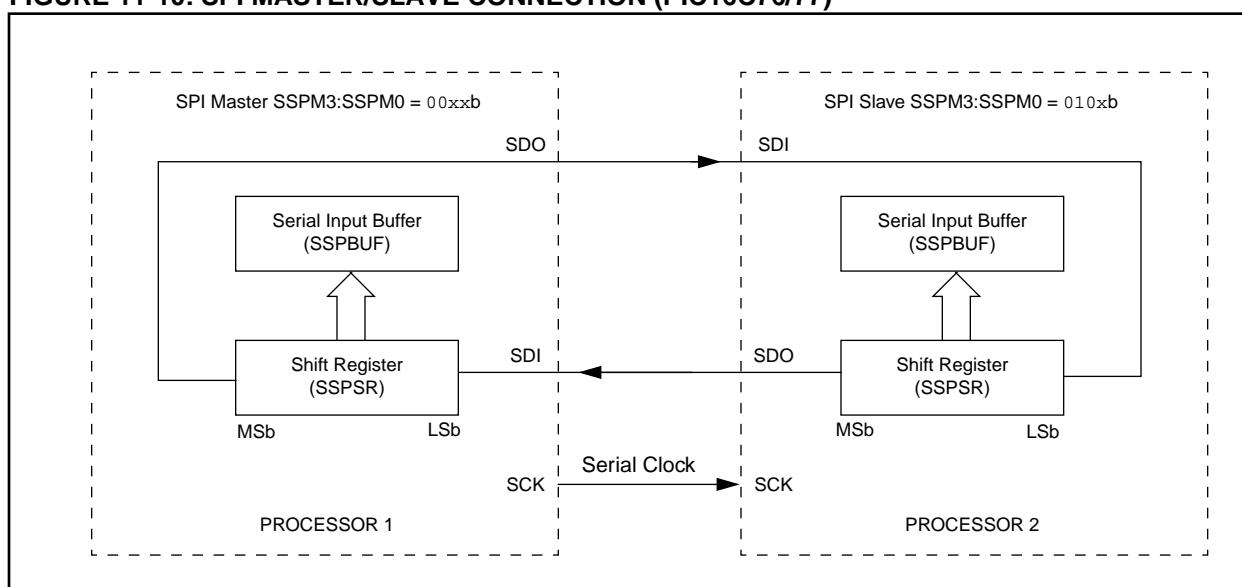
The clock polarity is selected by appropriately programming bit CKP (SSPCON<4>). This then would give waveforms for SPI communication as shown in Figure 11-11, Figure 11-12, and Figure 11-13 where the MSB is transmitted first. In master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 • Tcy)
- Fosc/64 (or 16 • Tcy)
- Timer2 output/2

This allows a maximum bit clock frequency (at 20 MHz) of 5 MHz. When in slave mode the external clock must meet the minimum high and low times.

In sleep mode, the slave can transmit and receive data and wake the device from sleep.

FIGURE 11-10: SPI MASTER/SLAVE CONNECTION (PIC16C76/77)



12.1 USART Baud Rate Generator (BRG)

Applicable Devices							
72	73	73A	74	74A	76	77	

The BRG supports both the Asynchronous and Synchronous modes of the USART. It is a dedicated 8-bit baud rate generator. The SPBRG register controls the period of a free running 8-bit timer. In asynchronous mode bit BRGH (TXSTA<2>) also controls the baud rate. In synchronous mode bit BRGH is ignored. Table 12-1 shows the formula for computation of the baud rate for different USART modes which only apply in master mode (internal clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRG register can be calculated using the formula in Table 12-1. From this, the error in baud rate can be determined.

Example 12-1 shows the calculation of the baud rate error for the following conditions:

Fosc = 16 MHz
 Desired Baud Rate = 9600
 BRGH = 0
 SYNC = 0

EXAMPLE 12-1: CALCULATING BAUD RATE ERROR

Desired Baud rate = Fosc / (64 (X + 1))

$$9600 = 16000000 / (64 (X + 1))$$

$$X = \lfloor 25.042 \rfloor = 25$$

Calculated Baud Rate = $16000000 / (64 (25 + 1))$

$$= 9615$$

$$\text{Error} = \frac{(\text{Calculated Baud Rate} - \text{Desired Baud Rate})}{\text{Desired Baud Rate}}$$

$$= (9615 - 9600) / 9600$$

$$= 0.16\%$$

It may be advantageous to use the high baud rate (BRGH = 1) even for slower baud clocks. This is because the $Fosc/(16(X + 1))$ equation can reduce the baud rate error in some cases.

Note: For the PIC16C73/73A/74/74A, the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information, or use the PIC16C76/77.

Writing a new value to the SPBRG register, causes the BRG timer to be reset (or cleared), this ensures the BRG does not wait for a timer overflow before outputting the new baud rate.

TABLE 12-1: BAUD RATE FORMULA

SYNC	BRGH = 0 (Low Speed)	BRGH = 1 (High Speed)
0	(Asynchronous) Baud Rate = $Fosc/(64(X+1))$	Baud Rate = $Fosc/(16(X+1))$
1	(Synchronous) Baud Rate = $Fosc/(4(X+1))$	NA

X = value in SPBRG (0 to 255)

TABLE 12-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
18h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00x
99h	SPBRG	Baud Rate Generator Register								0000 0000	0000 0000

Legend: x = unknown, - = unimplemented read as '0'. Shaded cells are not used by the BRG.

TABLE 12-5: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 1)

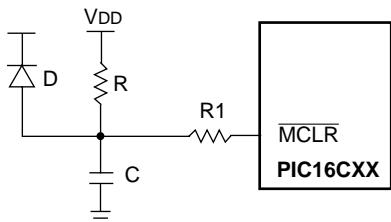
BAUD RATE (K)	FOSC = 20 MHz			16 MHz			10 MHz			7.16 MHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
9.6	9.615	+0.16	129	9.615	+0.16	103	9.615	+0.16	64	9.520	-0.83	46
19.2	19.230	+0.16	64	19.230	+0.16	51	18.939	-1.36	32	19.454	+1.32	22
38.4	37.878	-1.36	32	38.461	+0.16	25	39.062	+1.7	15	37.286	-2.90	11
57.6	56.818	-1.36	21	58.823	+2.12	16	56.818	-1.36	10	55.930	-2.90	7
115.2	113.636	-1.36	10	111.111	-3.55	8	125	+8.51	4	111.860	-2.90	3
250	250	0	4	250	0	3	NA	-	-	NA	-	-
625	625	0	1	NA	-	-	625	0	0	NA	-	-
1250	1250	0	0	NA	-	-	NA	-	-	NA	-	-

BAUD RATE (K)	FOSC = 5.068 MHz			4 MHz			3.579 MHz			1 MHz			32.768 kHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
9.6	9.6	0	32	NA	-	-	9.727	+1.32	22	8.928	-6.99	6	NA	-	-
19.2	18.645	-2.94	16	1.202	+0.17	207	18.643	-2.90	11	20.833	+8.51	2	NA	-	-
38.4	39.6	+3.12	7	2.403	+0.13	103	37.286	-2.90	5	31.25	-18.61	1	NA	-	-
57.6	52.8	-8.33	5	9.615	+0.16	25	55.930	-2.90	3	62.5	+8.51	0	NA	-	-
115.2	105.6	-8.33	2	19.231	+0.16	12	111.860	-2.90	1	NA	-	-	NA	-	-
250	NA	-	-	NA	-	-	223.721	-10.51	0	NA	-	-	NA	-	-
625	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1250	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-

Note: For the PIC16C73/73A/74/74A, the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information, or use the PIC16C76/77.

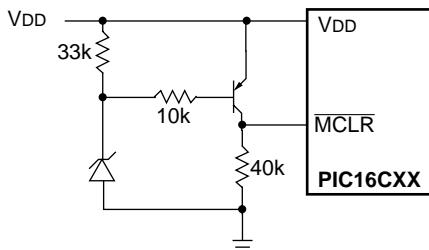
PIC16C7X

FIGURE 14-13: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW V_{DD} POWER-UP)



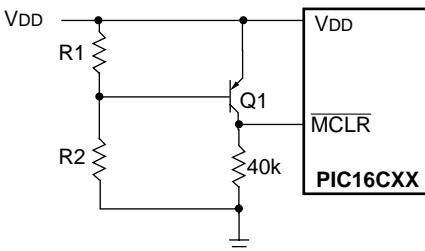
- 1: External Power-on Reset circuit is required only if V_{DD} power-up slope is too slow. The diode D helps discharge the capacitor quickly when V_{DD} powers down.
- 2: R < 40 kΩ is recommended to make sure that voltage drop across R does not violate the device's electrical specification.
- 3: R₁ = 100Ω to 1 kΩ will limit any current flowing into MCLR from external capacitor C in the event of MCLR/VPP pin breakdown due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

FIGURE 14-14: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1



- 1: This circuit will activate reset when V_{DD} goes below (V_Z + 0.7V) where V_Z = Zener voltage.
- 2: Internal brown-out detection on the PIC16C72/73A/74A/76/77 should be disabled when using this circuit.
- 3: Resistors should be adjusted for the characteristics of the transistor.

FIGURE 14-15: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2



- 1: This brown-out circuit is less expensive, albeit less accurate. Transistor Q1 turns off when V_{DD} is below a certain level such that:

$$V_{DD} \cdot \frac{R_1}{R_1 + R_2} = 0.7V$$

- 2: Internal brown-out detection on the PIC16C72/73A/74A/76/77 should be disabled when using this circuit.
- 3: Resistors should be adjusted for the characteristics of the transistor.

NOP	No Operation			
Syntax:	[<i>label</i>] NOP			
Operands:	None			
Operation:	No operation			
Status Affected:	None			
Encoding:	00	0000	0xx0	0000
Description:	No operation.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	No-Operation	No-Operation	No-Operation

Example NOP

RETFIE	Return from Interrupt			
Syntax:	[<i>label</i>] RETFIE			
Operands:	None			
Operation:	TOS → PC, 1 → GIE			
Status Affected:	None			
Encoding:	00	0000	0000	1001
Description:	Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two cycle instruction.			
Words:	1			
Cycles:	2			
Q Cycle Activity:	Q1	Q2	Q3	Q4
1st Cycle	Decode	No-Operation	Set the GIE bit	Pop from the Stack
2nd Cycle	No-Operation	No-Operation	No-Operation	No-Operation

Example RETFIE

After Interrupt

PC = TOS
GIE = 1

OPTION	Load Option Register			
Syntax:	[<i>label</i>] OPTION			
Operands:	None			
Operation:	(W) → OPTION			
Status Affected:	None			
Encoding:	00	0000	0110	0010
Description:	The contents of the W register are loaded in the OPTION register. This instruction is supported for code compatibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it.			
Words:	1			
Cycles:	1			
Example	<p>To maintain upward compatibility with future PIC16CXX products, do not use this instruction.</p>			

SUBWF	Subtract W from f			
Syntax:	[label] SUBWF f,d			
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]			
Operation:	(f) - (W) → (destination)			
Status Affected:	C, DC, Z			
Encoding:	00 0010 dfff ffff			
Description:	Subtract (2's complement method) W register from register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1 Q2 Q3 Q4			
	Decode	Read register 'f'	Process data	Write to destination

Example 1: SUBWF REG1, 1

Before Instruction

REG1	=	3
W	=	2
C	=	?
Z	=	?

After Instruction

REG1	=	1
W	=	2
C	=	1; result is positive
Z	=	0

Example 2: Before Instruction

REG1	=	2
W	=	2
C	=	?
Z	=	?

After Instruction

REG1	=	0
W	=	2
C	=	1; result is zero
Z	=	1

Example 3: Before Instruction

REG1	=	1
W	=	2
C	=	?
Z	=	?

After Instruction

REG1	=	0xFF
W	=	2
C	=	0; result is negative
Z	=	0

SWAPF	Swap Nibbles in f			
Syntax:	[label] SWAPF f,d			
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]			
Operation:	(f<3:0>) → (destination<7:4>), (f<7:4>) → (destination<3:0>)			
Status Affected:	None			
Encoding:	00 1110 dfff ffff			
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1 Q2 Q3 Q4			
	Decode	Read register 'f'	Process data	Write to destination

Example: SWAPF REG, 0

Before Instruction

REG1	=	0xA5
W	=	0x5A

After Instruction

REG1	=	0xA5
W	=	0x5A

TRIS	Load TRIS Register			
Syntax:	[label] TRIS f			
Operands:	5 ≤ f ≤ 7			
Operation:	(W) → TRIS register f;			
Status Affected:	None			
Encoding:	00 0000 0110 0fff			
Description:	The instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them.			
Words:	1			
Cycles:	1			
Example	To maintain upward compatibility with future PIC16CXX products, do not use this instruction.			

PIC16C7X

Applicable Devices | 72 | 73 | 73A | 74 | 74A | 76 | 77 |

FIGURE 17-3: CLKOUT AND I/O TIMING

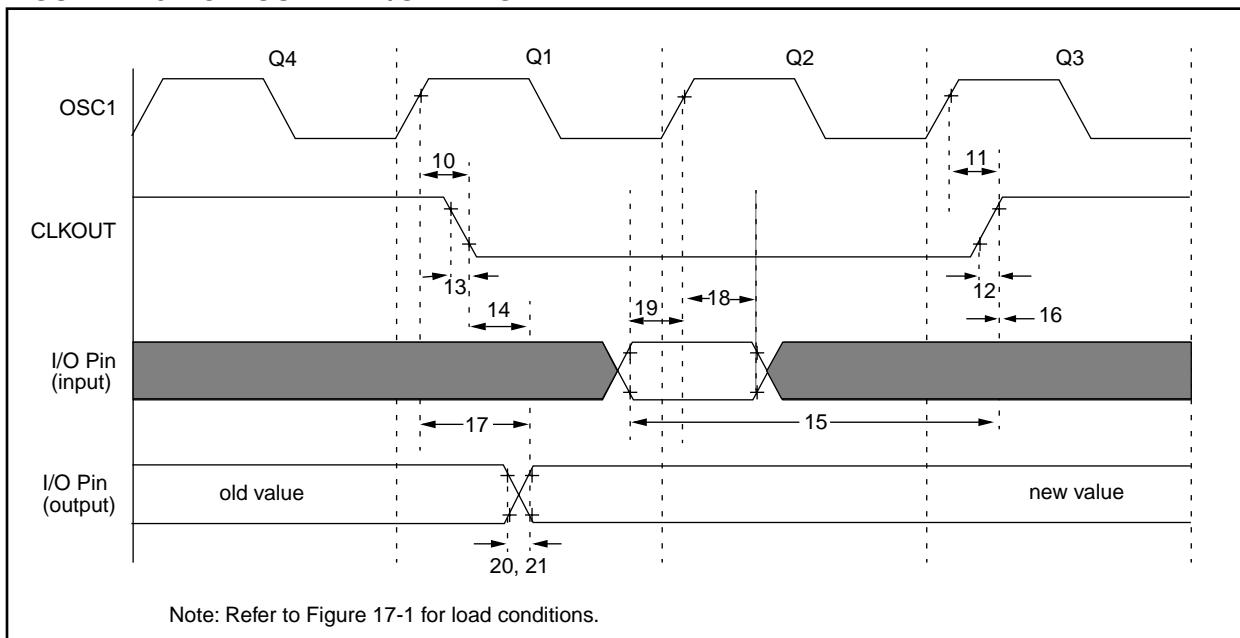


TABLE 17-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Ty†	Max	Units	Conditions
10*	Tosh2ckL	OSC1↑ to CLKOUT↓		—	75	200	ns	Note 1
11*	Tosh2ckH	OSC1↑ to CLKOUT↑		—	75	200	ns	Note 1
12*	TckR	CLKOUT rise time		—	35	100	ns	Note 1
13*	TckF	CLKOUT fall time		—	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid		—	—	0.5TCY + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑	Tosc + 200	—	—	—	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT ↑	0	—	—	—	ns	Note 1
17*	Tosh2ioV	OSC1↑ (Q1 cycle) to Port out valid		—	50	150	ns	
18*	Tosh2iol	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	PIC16C72 PIC16LC72	100 200	— —	— —	ns ns	
19*	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	0	—	—	—	ns	
20*	TioR	Port output rise time	PIC16C72 PIC16LC72	— —	10 80	40	ns ns	
21*	TioF	Port output fall time	PIC16C72 PIC16LC72	— —	10 80	40	ns ns	
22††*	Tinp	INT pin high or low time		TCY	—	—	ns	
23††*	Trbp	RB7:RB4 change INT high or low time		TCY	—	—	ns	

* These parameters are characterized but not tested.

†Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

†† These parameters are asynchronous events not related to any internal clock edges.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

20.1 DC Characteristics: PIC16C76/77-04 (Commercial, Industrial, Extended)
 PIC16C76/77-10 (Commercial, Industrial, Extended)
 PIC16C76/77-20 (Commercial, Industrial, Extended)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated)									
		Operating temperature		-40°C	≤ TA ≤ +125°C	for extended,	-40°C	≤ TA ≤ +85°C	for industrial and	0°C	≤ TA ≤ +70°C
Param No.	Characteristic	Sym	Min	Typt	Max	Units	Conditions				
D001 D001A	Supply Voltage	VDD	4.0 4.5	-	6.0 5.5	V	XT, RC and LP osc configuration HS osc configuration				
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V					
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details				
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details				
D005	Brown-out Reset Voltage	BVDD	3.7 3.7	4.0 4.0	4.3 4.4	V	BODEN bit in configuration word enabled Extended Range Only				
D010	Supply Current (Note 2,5)	IDD	-	2.7	5	mA	XT, RC osc configuration Fosc = 4 MHz, VDD = 5.5V (Note 4)				
D013			-	10	20	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V				
D015*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μA	BOR enabled VDD = 5.0V				
D020 D021 D021A D021B	Power-down Current (Note 3,5)	IPD	- - - -	10.5 1.5 1.5 2.5	42 16 19 19	μA	VDD = 4.0V, WDT enabled, -40°C to +85°C VDD = 4.0V, WDT disabled, -0°C to +70°C VDD = 4.0V, WDT disabled, -40°C to +85°C VDD = 4.0V, WDT disabled, -40°C to +125°C				
D023*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μA	BOR enabled VDD = 5.0V				

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD

MCLR = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula $I_r = VDD/2Rext$ (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

FIGURE 20-8: PARALLEL SLAVE PORT TIMING (PIC16C77)

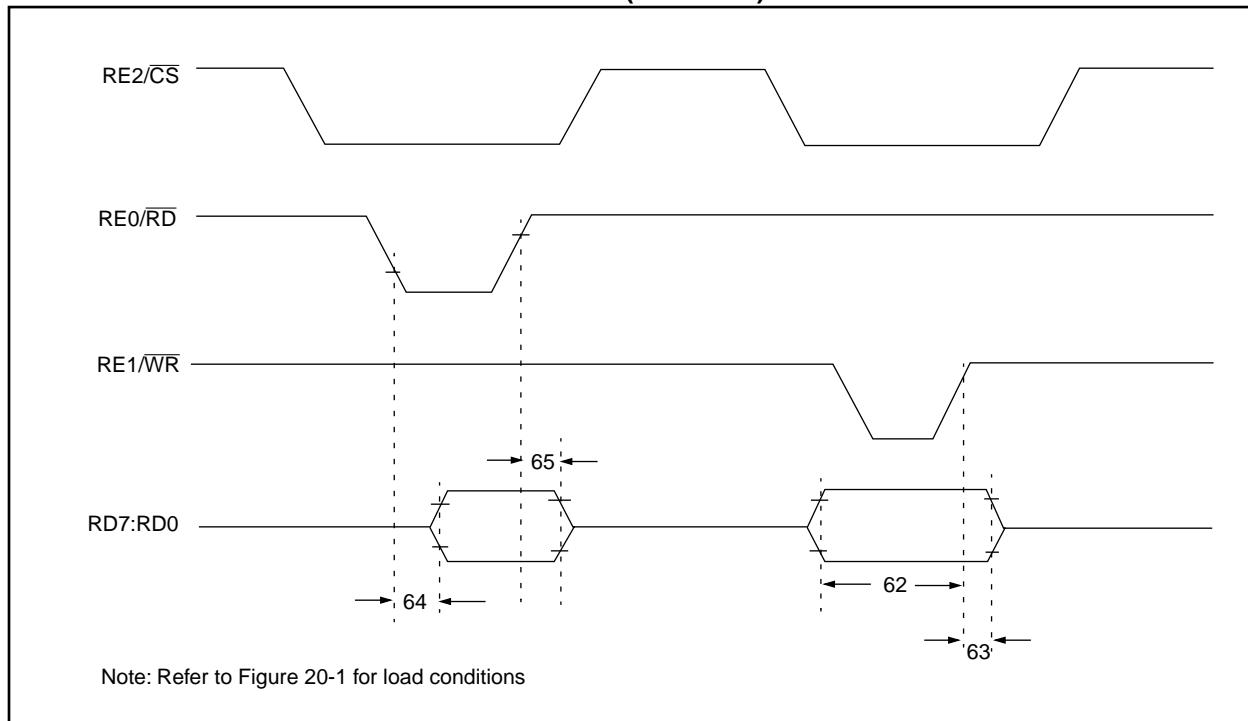


TABLE 20-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C77)

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
62	TdtV2wrH	Data in valid before $\overline{WR} \uparrow$ or $\overline{CS} \uparrow$ (setup time)	20 25	— —	— —	ns ns	Extended Range Only
63*	TwrH2dtl	$\overline{WR} \uparrow$ or $\overline{CS} \uparrow$ to data-in invalid (hold time)	PIC16C77	20	—	ns	
			PIC16LC77	35	—	ns	
64	TrdL2dtV	$\overline{RD} \downarrow$ and $\overline{CS} \downarrow$ to data-out valid	— —	— —	80 90	ns ns	Extended Range Only
65	TrdH2dtI	$\overline{RD} \uparrow$ or $\overline{CS} \downarrow$ to data-out invalid	10	—	30	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

21.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed.

In some graphs or tables the data presented are outside specified operating range (i.e., outside specified V_{DD} range). This is for information only and devices are guaranteed to operate properly only within the specified range.

Note: The data presented in this section is a statistical summary of data collected on units from different lots over a period of time and matrix samples. 'Typical' represents the mean of the distribution at, 25°C, while 'max' or 'min' represents (mean +3σ) and (mean -3σ) respectively where σ is standard deviation.

FIGURE 21-1: TYPICAL IPD VS. VDD (WDT DISABLED, RC MODE)

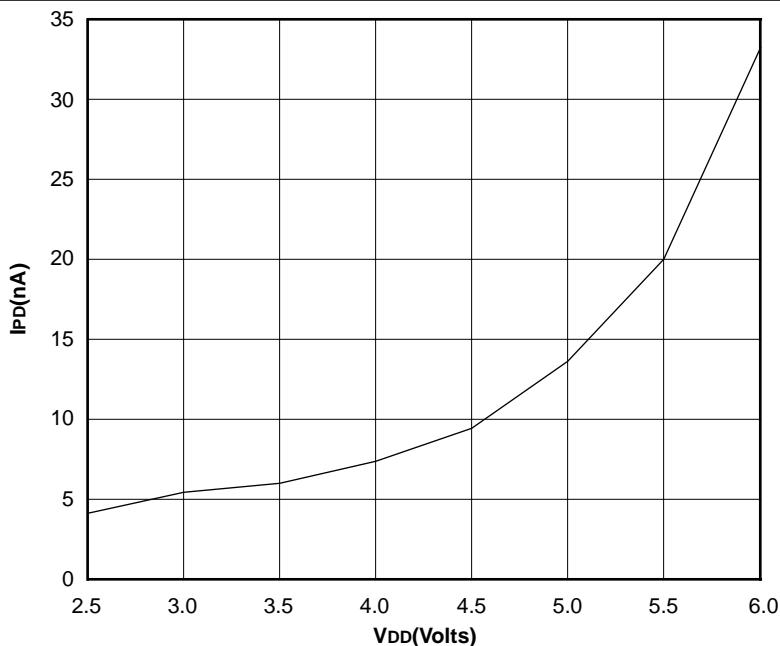
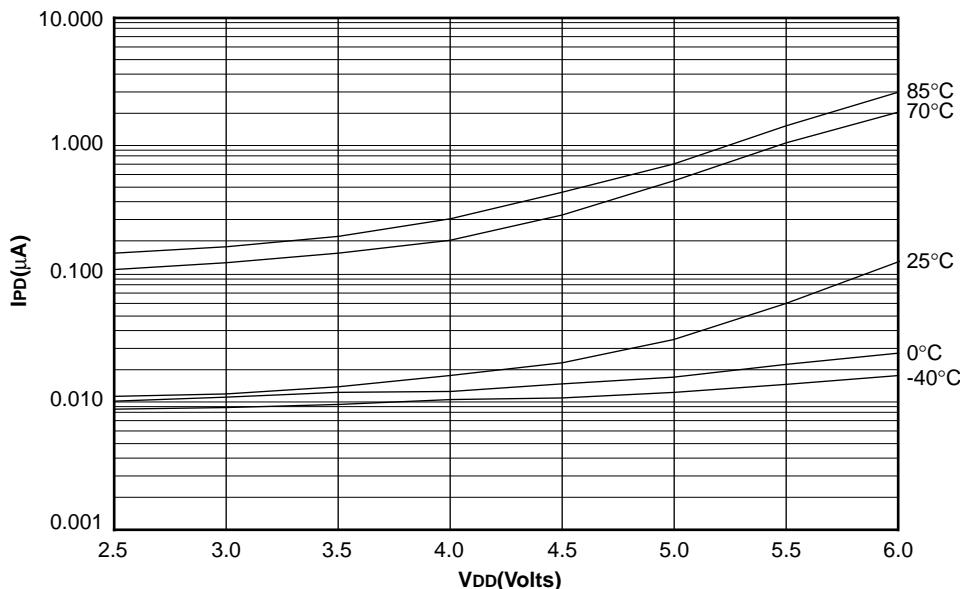


FIGURE 21-2: MAXIMUM IPD VS. VDD (WDT DISABLED, RC MODE)



Applicable Devices | 72 | 73 | 73A | 74 | 74A | 76 | 77

FIGURE 21-14: TYPICAL IDD vs. FREQUENCY (RC MODE @ 100 pF, 25°C)

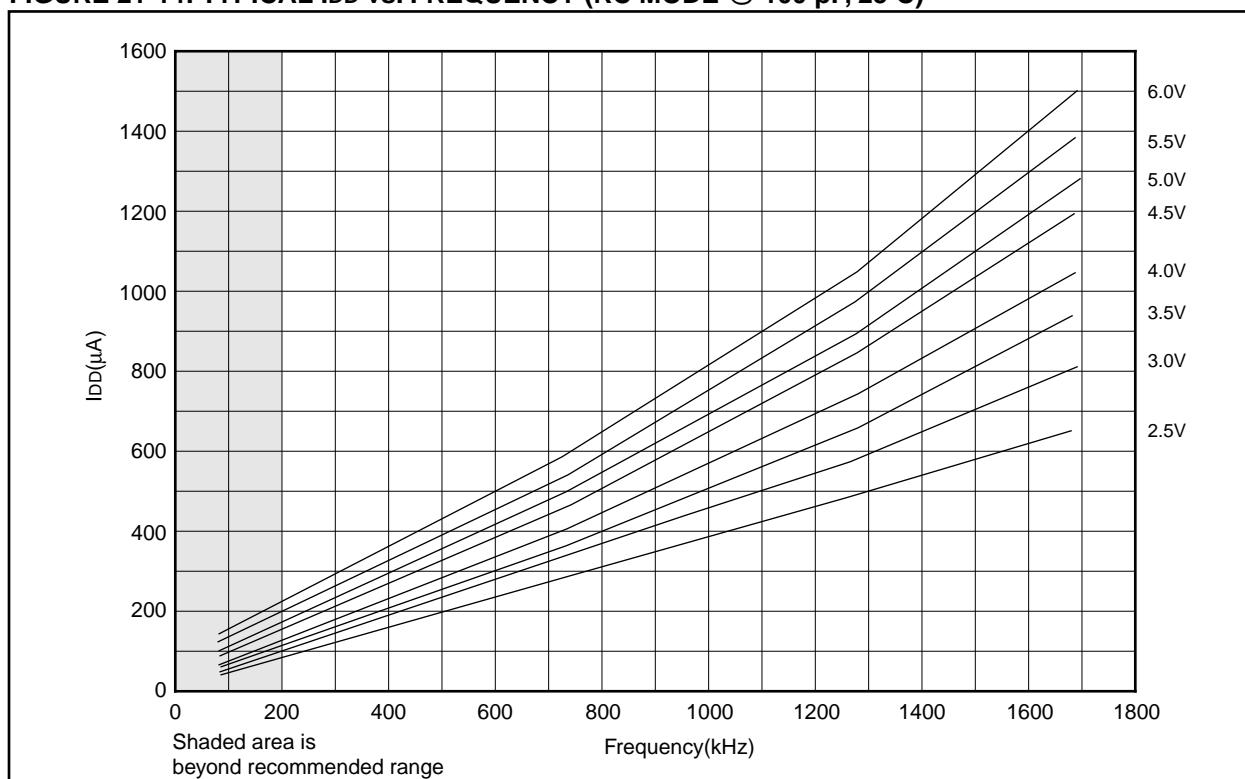
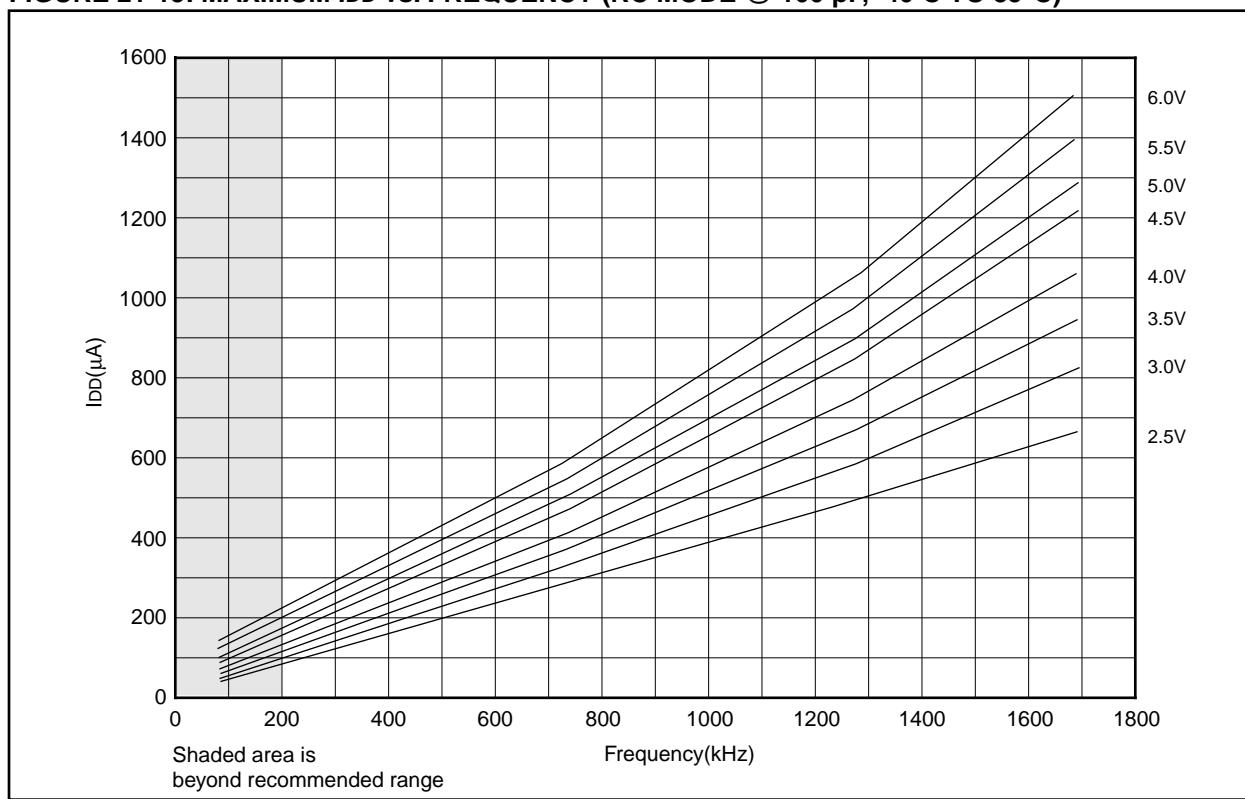


FIGURE 21-15: MAXIMUM IDD vs. FREQUENCY (RC MODE @ 100 pF, -40°C TO 85°C)

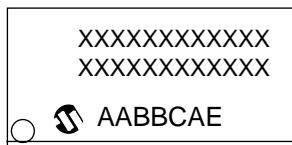


Data based on matrix samples. See first page of this section for details.

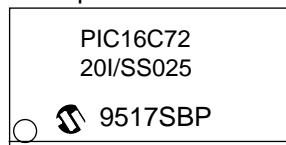
PIC16C7X

22.10 Package Marking Information

28-Lead SSOP



Example



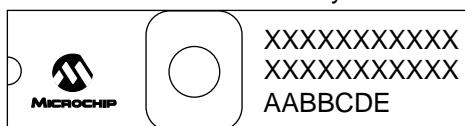
28-Lead PDIP (Skinny DIP)



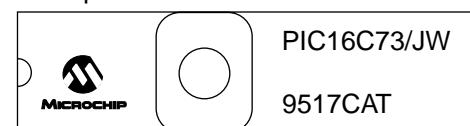
Example



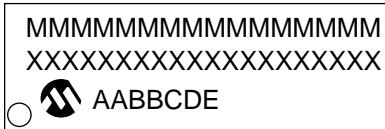
28-Lead Side Brazed Skinny Windowed



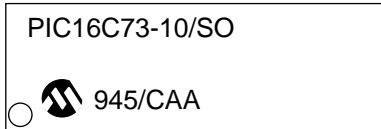
Example



28-Lead SOIC



Example



Legend:

MM...M Microchip part number information
XX...X Customer specific information*
AA Year code (last 2 digits of calendar year)
BB Week code (week of January 1 is week '01')
C Facility code of the plant at which wafer is manufactured.
C = Chandler, Arizona, U.S.A.
S = Tempe, Arizona, U.S.A.
D1 Mask revision number for microcontroller
E Assembly code of the plant or country of origin in which part was assembled.

Note:

In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

* Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask revision number, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

PIN COMPATIBILITY

Devices that have the same package type and VDD, Vss and MCLR pin locations are said to be pin compatible. This allows these different devices to operate in the same socket. Compatible devices may only require minor software modification to allow proper operation in the application socket (ex., PIC16C56 and PIC16C61 devices). Not all devices in the same package size are pin compatible; for example, the PIC16C62 is compatible with the PIC16C63, but not the PIC16C55.

Pin compatibility does not mean that the devices offer the same features. As an example, the PIC16C54 is pin compatible with the PIC16C71, but does not have an A/D converter, weak pull-ups on PORTB, or interrupts.

TABLE E-1: PIN COMPATIBLE DEVICES

Pin Compatible Devices	Package
PIC12C508, PIC12C509, PIC12C671, PIC12C672	8-pin
PIC16C154, PIC16CR154, PIC16C156, PIC16CR156, PIC16C158, PIC16CR158, PIC16C52, PIC16C54, PIC16C54A, PIC16CR54A, PIC16C56, PIC16C58A, PIC16CR58A, PIC16C61, PIC16C554, PIC16C556, PIC16C558, PIC16C620, PIC16C621, PIC16C622, PIC16C641, PIC16C642, PIC16C661, PIC16C662, PIC16C710, PIC16C71, PIC16C711, PIC16C715, PIC16F83, PIC16CR83, PIC16F84A, PIC16CR84	18-pin, 20-pin
PIC16C55, PIC16C57, PIC16CR57B	28-pin
PIC16CR62, PIC16C62A, PIC16C63, PIC16CR63, PIC16C66, PIC16C72, PIC16C73A, PIC16C76	28-pin
PIC16CR64, PIC16C64A, PIC16C65A, PIC16CR65, PIC16C67, PIC16C74A, PIC16C77	40-pin
PIC17CR42, PIC17C42A, PIC17C43, PIC17CR43, PIC17C44	40-pin
PIC16C923, PIC16C924	64/68-pin
PIC17C756, PIC17C752	64/68-pin

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BSF	150
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